AMENDMENTS TO THE SPECIFICATION:

Please replace the paragraph appearing on page 7, lines 8-18, with the following amended paragraph:

> The ICMS device 120 may also be used with other leads, such as, for example, a subcutaneous lead 130. The subcutaneous lead 130 may be used for monitoring and/or stimulation in combination with one or more of the intramyocardial lead(s) 110. For example, subcutaneous leads that may be used in cooperation with the ICMS system 100 are disclosed in commonly owned US Patent Application Publication US 2004/0230230 (Lindstrom et al.) ~~Number 10/465,520, filed June 19, 2003 [Attorney Docket Number GUID.615PA]~~, which is hereby incorporated herein by reference. One or more intramyocardial leads 110 may further be used in combination with a subcutaneous monitoring and/or stimulation device of the type disclosed in commonly owned US Patent Application Publication US 2004/0230229 (Lovett et al.) ~~Number 10/462,001, filed June 13, 2003 [Attorney Docket Number GUID.612PA]~~, which is hereby incorporated herein by reference.

Please replace the paragraph appearing on page 14, lines 12-23, with the following amended paragraph:

> In one particular configuration, the first polymer material may include a first type of PTFE (polytetrafluoroethylene), and the second polymer material of the adhesion sites 460 may include a second type of PTFE. In one particular arrangement, the first type of PTFE includes a first type of ePTFE (expanded polytetrafluoroethylene), and the second type of PTFE includes a second type of ePTFE. The second type of ePTFE preferably differs from the first type of ePTFE in terms of one or more of porosity, pore sizes or distribution of pore sizes. Additional details of fixation approaches involving surface texturing, selective material use, and other arrangements that facilitate lead/electrode fixation via tissue ingrowth are disclosed in commonly owned U.S. Patent 6,961,621 (Krishnan et al.), ~~Application Serial No. 10/004,708 (GUID.031US01) filed December 4, 2001 and entitled "Apparatus and Method for Stabilizing an Implantable Lead,"~~ which is hereby incorporated herein by reference.